

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|------|--|---|------------------|---------|------------------|
| L1 | 1 | ("5917601").PN. | US-PGPUB; USPAT | OR | OFF | 2005/08/03 15:31 |
| L2 | 1050 | wafer near3 position near3 edge | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 15:32 |
| L3 | 21 | 2 and array with position with sens\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 16:43 |
| L4 | 1131 | wafer with displacement with position | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 15:40 |
| L5 | 60 | 2 and 4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 15:40 |
| L6 | 416 | wafer with displacement with measuring | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 15:40 |
| L7 | 6 | 2 and 6 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 15:41 |
| L8 | 198 | laser adj distance adj sens\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 15:41 |
| L9 | 18 | 8 and wafer | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 15:46 |

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|-----|--------|---|---|----|-----|------------------|
| L10 | 1 | ("5886521").PN. | US-PGPUB; USPAT | OR | OFF | 2005/08/03 16:30 |
| L11 | 1 | ("4819167").PN. | US-PGPUB; USPAT | OR | OFF | 2005/08/03 16:30 |
| L12 | 1 | "4449885".PN. | USPAT; USOCR | OR | ON | 2005/08/03 16:30 |
| L13 | 1 | "4507078".PN. | USPAT; USOCR | OR | ON | 2005/08/03 16:31 |
| L14 | 1 | "4523985".PN. | USPAT; USOCR | OR | ON | 2005/08/03 16:31 |
| L15 | 1 | "4647266".PN. | USPAT; USOCR | OR | ON | 2005/08/03 16:31 |
| L16 | 1 | "4705951".PN. | USPAT; USOCR | OR | ON | 2005/08/03 16:31 |
| L17 | 1 | "4720635".PN. | USPAT; USOCR | OR | ON | 2005/08/03 16:32 |
| L18 | 107580 | (wafer or substrate) near2 position\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 16:43 |
| L19 | 7055 | (wafer or substrate) near2 position\$4.ti. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 16:58 |
| L20 | 23 | 19 and array with sens\$4 with position | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 16:58 |
| L21 | 182 | (wafer or substrate) near2 position\$4 near4 measur\$4.ti. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 16:50 |
| L22 | 1 | 21 and array with sens\$4 with position | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 16:51 |

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| L23 | 2494 | wafer near4 thickness near4 measur\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 16:58 |
| L24 | 127 | 23 and (wafer or substrate) near2 position\$4 near3 measur\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:07 |
| L25 | 6 | 24 and eddy adj current | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:10 |
| L26 | 331 | 324/230.ccls. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:37 |
| L27 | 116 | 26 and (wafer or substrate) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:11 |
| L28 | 7 | 27 and array near4 sens\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:16 |
| L29 | 147 | 23 and determin\$4 near2 position | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:17 |
| L30 | 7 | 29 and eddy adj current | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:17 |

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| L31 | 441 | 324/229.ccls. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:37 |
| L32 | 88 | 26 and gap | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/08/03 17:37 |